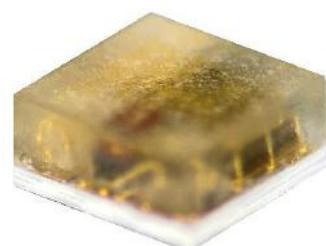


Features

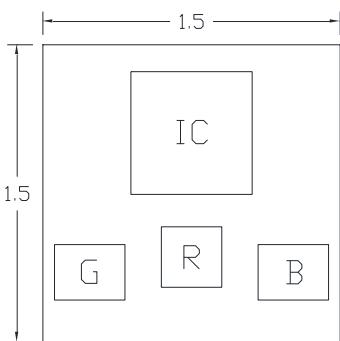
1. RoHS compliant
2. Support RGB color display and in a single addressable LED
3. Cascading port transmission by dual-wire (clock & data)
4. Built-in current regulator, three-way drive.
5. 256-step gray scale output to allow 16M color display.
6. 32 step dimming control.
7. Built-in oscillator 20MHZ
8. Maximum serial input data / clock frequency 15MHZ
9. Built-in power on reset (2.6V @ VDD=5V)
10. Support sleep and wake up mode for power saving.

Main Applications

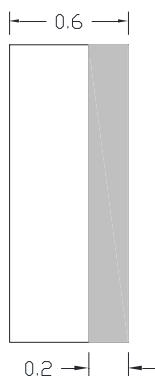
- Decorative LED Lighting
- Automotive Interior Ambient lighting



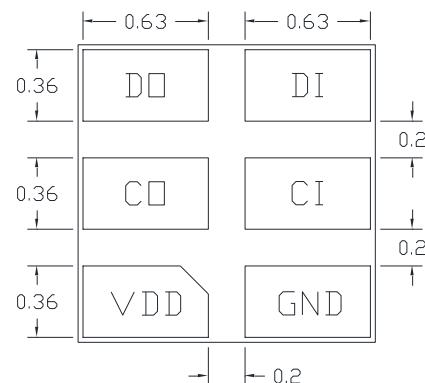
Mechanical Dimensions



Top view



Side view



Bottom view

| Pin Name | Function Description |
|----------|----------------------|
| VDD | Power supply |
| GND | Ground |
| DI | Serial data input |
| DO | Serial data output |
| CI | Clock signal input |
| CO | Clock signal output |

Notes

1. Drawing not to scale.
2. All dimensions are in millimeters.
3. Unless otherwise indicated, tolerances are ± 0.05 mm.
4. Please do not use a force of over 0.3kgf impact or pressure on the lens of the LED, otherwise

Absolute Maximum Ratings, $T_a = 25^\circ\text{C}$

(unless otherwise specified, Temperature=25°C)

| Parameter | Symbol | Rating | Unit |
|-----------------------------|--------------|---------|------|
| Supply Voltage | V_{DD} | 6.5 | V |
| Power Dissipation | P_D | <400 | mW |
| Maximum Output Current | I_{LEDOUT} | 25 | mA |
| Operating Temperature Range | T_{OPR} | -40~105 | °C |
| Storage Temperature Range | T_{STO} | -40~125 | °C |

Electrical / Optical Characteristics, $T_a = 25^\circ\text{C}$

| Parameter | Symbol | Color | Min. | Typ. | Max. | Unit |
|---------------------|-----------------|-------|------|------|------|------|
| Luminous Intensity | IV | Red | 400 | - | 1000 | mcd |
| | | Green | 800 | - | 2000 | |
| | | Blue | 150 | - | 300 | |
| Dominant Wavelength | λ_d | Red | 620 | - | 630 | nm |
| | | Green | 520 | - | 535 | |
| | | Blue | 460 | - | 475 | |
| View Angle | $2\theta_{1/2}$ | - | 120 | | | deg |

- Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- The dominant wavelength, λ_d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device. Peak Emission Wavelength Tolerance is +/- 1nm.

Electrical Characteristics

(unless otherwise specified, Temperature=25°C & VDD=5.0V)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Note |
|-------------------------------------|--------------------|------|------|----------------------|------|---|
| Supply Voltage | V _{DD} | 3.3 | 5.0 | 5.5 | V | |
| Operation current | I _{dyn} | - | - | 1.5 | mA | RGB No load(off) |
| Standby Current | I _{sleep} | - | 1 | 10 | uA | |
| Logic input control DIN/CIN | | | | | | |
| Input High "H" | V _{IH} | 2.7 | - | V _{DD} +0.4 | V | |
| Input High "L" | V _{IL} | -0.4 | - | 1.0 | V | |
| DIN Pull-up resistance @normal mode | R _{IN} | - | 80K | - | Ω | |
| CIN Frequency | C _{FREQ} | - | - | 15 | MHz | |
| CIN High pulse width | T _{CKH} | 30 | - | - | ns | |
| CIN Low pulse width | T _{CKL} | 30 | - | - | ns | |
| DIN to CIN setup | T _{SETUP} | 10 | - | - | ns | |
| DIN to CIN hold time | T _{HOLD} | 5 | - | - | ns | |
| Logic output DOUT/COUT | | | | | | |
| Output High "H" | V _{OH} | 4.5 | - | - | V | I _{OH} =4mA |
| Output High "L" | V _{OL} | - | - | 0.4 | V | I _{OL} =4mA |
| Sink Current R/G/B | | | | | | |
| AP6102Q-20 | I _{SINK} | 19 | 20 | 21 | mA | @V _{DD} -V _{f_{LED}} ≥ 1.5V |
| R、G、B off leakage current | I _{off} | - | - | 1 | uA | PWM off(0x00) |

Luminous Intensity Bin Structure at 20mA

| Color | Bin Code | Min. | Max. | Unit |
|-------|----------|------|------|------|
| Red | A | 400 | 1000 | mcd |
| Green | A | 800 | 2000 | |
| Blue | A | 150 | 300 | |

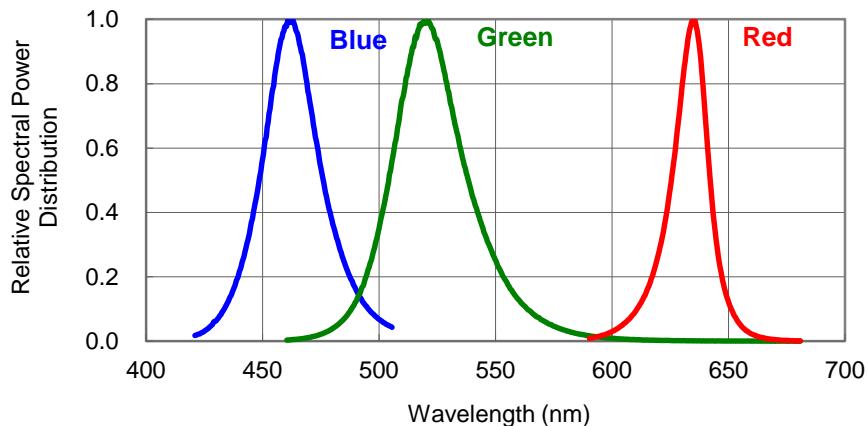
- AB maintains a tolerance of $\pm 10\%$ on flux and power measurements.
- The flux bin of the product may be modified for improvement without notice.

Dominant Wavelength Bin Structure at 20mA

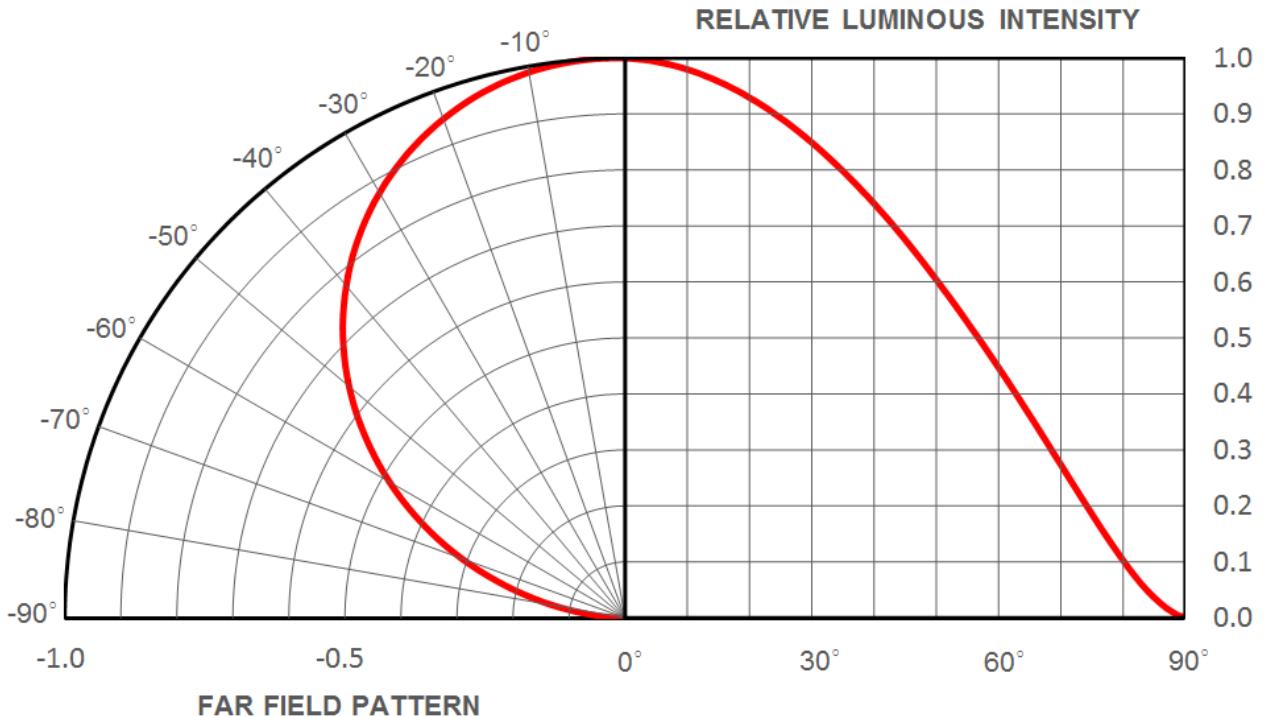
| Color | Bin Code | Min. | Max. | Unit |
|-------|----------|------|------|------|
| Red | 4 | 620 | 630 | nm |
| Green | 1 | 520 | 535 | |
| Blue | A | 460 | 475 | |

- AB maintains a tolerance of $\pm 1\text{nm}$ for dominant wavelength measurements.

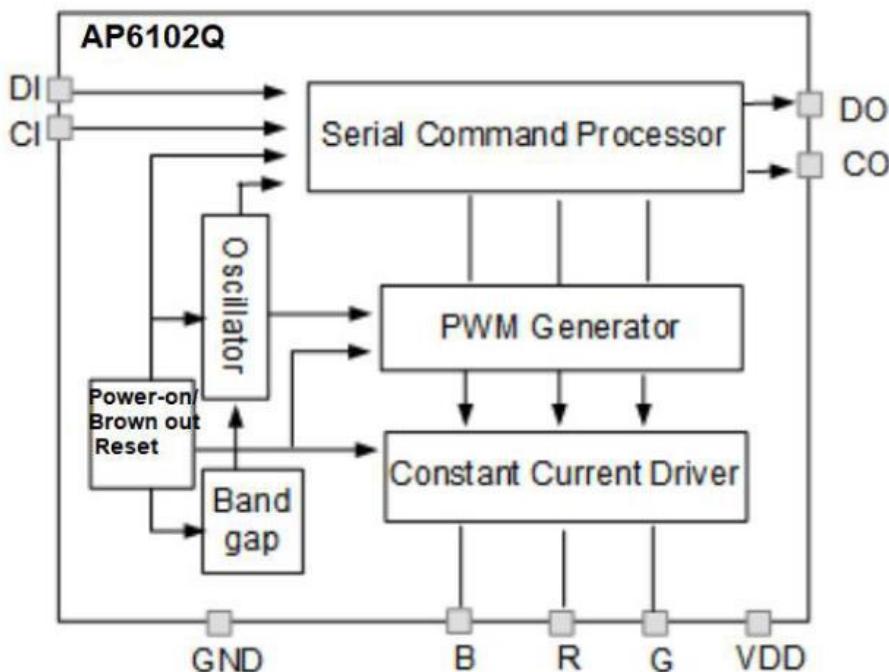
Color Spectrum, $T_a = 25^\circ\text{C}$



Typical Representative Spatial Radiation Pattern



Block Diagram



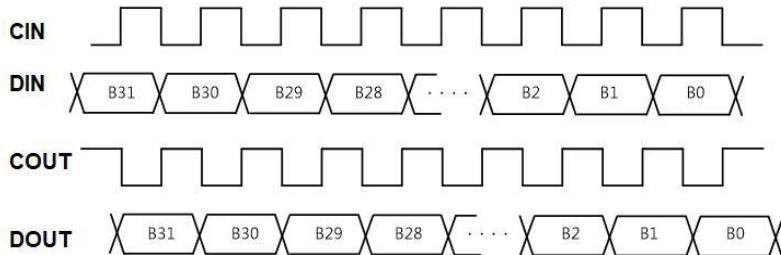
Pin Function Description

| Pin Name | IO | Description |
|----------|----|-------------------------|
| VDD | P | Power Supply |
| GND | G | Ground |
| DIN | I | Serial data input |
| CIN | I | Clock input |
| DOUT | O | Serial data output |
| COUT | O | Clock output |
| R | O | Red LED output driver |
| G | O | Green LED output driver |
| B | O | Blue LED output driver |

Command Set

| | | | | | | | | | | | | | |
|------------|-----------|--------------|-----------|------------|----------|-----------|-------|-------|-----------|--------------|-------|----------|----------------------------------|
| 32-bit 0's | FLAG[2:0] | DIMMING[4:0] | BLUE[7:0] | GREEN[7:0] | RED[7:0] | FLAG[2:0] | | | FLAG[2:0] | DIMMING[4:0] | | RED[7:0] | N/2 # of dummy data ("1" or "0") |
| Start | | | | | | | | | | | | | Need extra N/2 of clocks |

- 32 consecutive 0's denote the start of a command for an RGB LED. After receiving 320's, ST6N-26FFE-HD7C gets the following 32 bits as the received command, including FLAG, DIMMING, BLUE, GREEN and RED fields.



- The serial command is transmitted with MSB first, DIN is latched at the rising edge of CIN clock. COUT and DOUT are re-generated for the next RGB LED. COUT is inverted from CIN. When 32 consecutive 0's are encountered, the next 1 is expected to start a 32-bit command, i.e., FLAG[2:0]=111. When FLAG[2:0]=111, then DIMMING, BLUE, GREEN and RED fields are latched respectively.
- while the current 32-bit command is got, ST6N-26FFE-HD7C passes remaining command bits to the next RGB LED.
- After the last one command is issued for the last LED (LED n), MCU should issue the extra N/2 numbers of clocks signal if there are N LED lamps totally connected in the strip to make sure the data transfer and display of the last one LED lamp is complete and correct.(the data for the extra N/2 # of clocks may be set as "0" or "1")

| | | | | | | | | |
|------|------------|------------|------|------|-------|------------|------|------|
| LED1 | 32-bit 0's | LED1 | LED2 | LED3 | | 32-bit 0's | LED1 | LED2 |
| LED2 | | 32-bit 0's | LED2 | LED3 | | 32-bit 0's | LED2 | |

FLAG[2:0] : 111 to start a 32-bit command

DIMMING[4:0] : 32-level current control for R/G/B drivers

BLUE[7:0] : 256 gray levels for blue LED

GREEN[7:0] : 256 gray levels for green LED

RED[7:0] : 256 gray levels for red LED

Sleep and power saving mode

- Supports the sleep/wake-up modes for power-saving purpose. In sleep mode, the built-in oscillator and associated circuitry will be disabled. The quiescent current of is approximately 1uA(typ.).

Command Setup to enable sleep or wake up mode

- When receiving 24-bit 0's BGR data (that is BLUE[7:0]=8h00, G[7:0]=8h00, R[7:0]=8h00), in the meantime, both of the data in 3-bits' flag and 5-bits' DIMMING is 8h'A0'(that is FLAG[2:0]=3b101 and DIMMING[4:0]=5b00000), it will enter sleep mode.
- it wake up from sleep mode once receiving the new data with the data of Flag[2:0]、DIMMING[4:0] is not 8h"A0"; after wake-up, all sleeping circuits in return to normal working mode within 1ms. Since it take 1ms for a sleeping LED returning to normal function mode, it is recommended for a host to wait for 1ms to send display data and command after issuing a wake-up command.

Sleep power-saving mode example:

| | | | | | | |
|-----------|------------------|---------------------|-------------|--------------|------------|------------|
| 32 bits 0 | Flag[2:0]=3'b101 | Dimming[4]=5'b00000 | Blue[8'h00] | Green[8'h00] | Red[8'h00] | Sleep mode |
|-----------|------------------|---------------------|-------------|--------------|------------|------------|

Case 1:

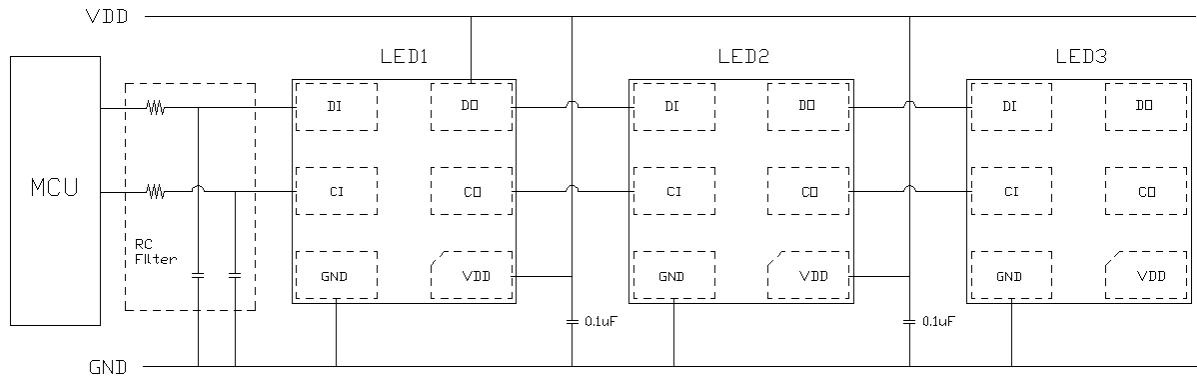
| Lamp 1 | Lamp 2 | Lamp 3 |
|----------------------|----------------------|----------------------|
| 1xx111118hFF8hFF8hFF | 101000008h008h008h00 | 101000008h008h008h00 |
| Normal mode | Sleep mode | Sleep mode |

Case 2:

| Lamp 1 | Lamp 2 | Lamp 3 |
|----------------------|----------------------|----------------------|
| 1xx111118hFF8hFF8hFF | 101000008h008h008h00 | 1xx111118h1F8h1F8h1F |
| Normal mode | Sleep mode | Normal mode |

- In case 2, while lamp2 is under sleep mode, in the following data transfer process, the state of lamp 2 will be not changed as long as the 32 bits data for lamp 2 is received with data of Flag[2:0] DIMMING[4:0] being 8h"A0". It means lamp2 will keep in sleep mode as well. In the situation, lamp2 can pass through the remaining data to lamp 3 (32bits) to change the display data of lamp 3. In other words, the sleeping chip is able to pass the data to the next chips.

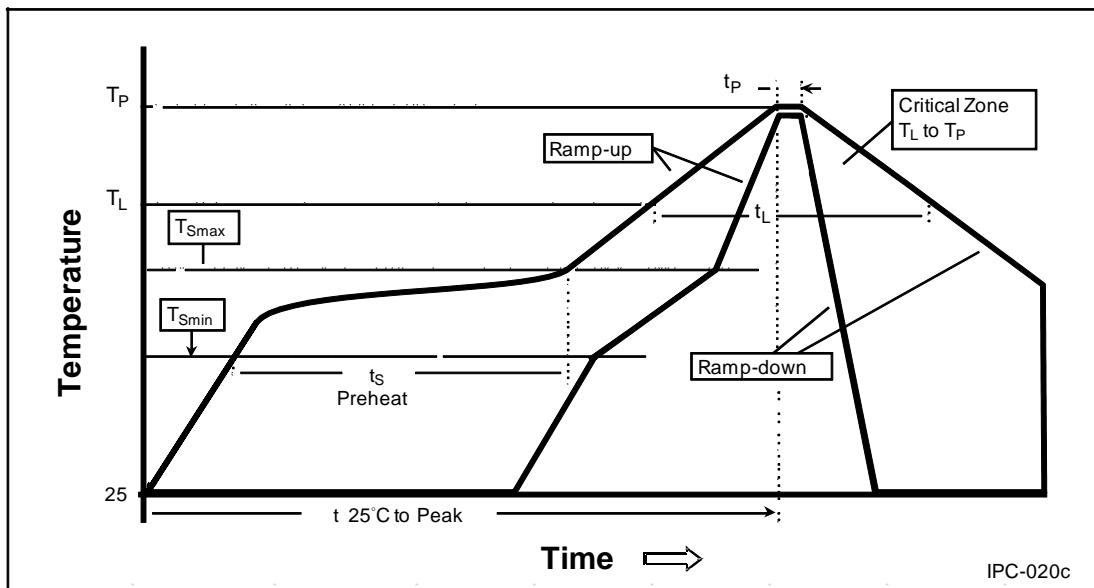
Typical Circuit of an RGB LED strip application



- RC Filter should be added or reserved on the board for better waveform of signals in different applications. The value is subject to the practical system environment.
- The by-pass capacitor of VDD pin is necessary to be added on the board for the stability of chip operation. The suggested value of capacitor is 0.1uF.

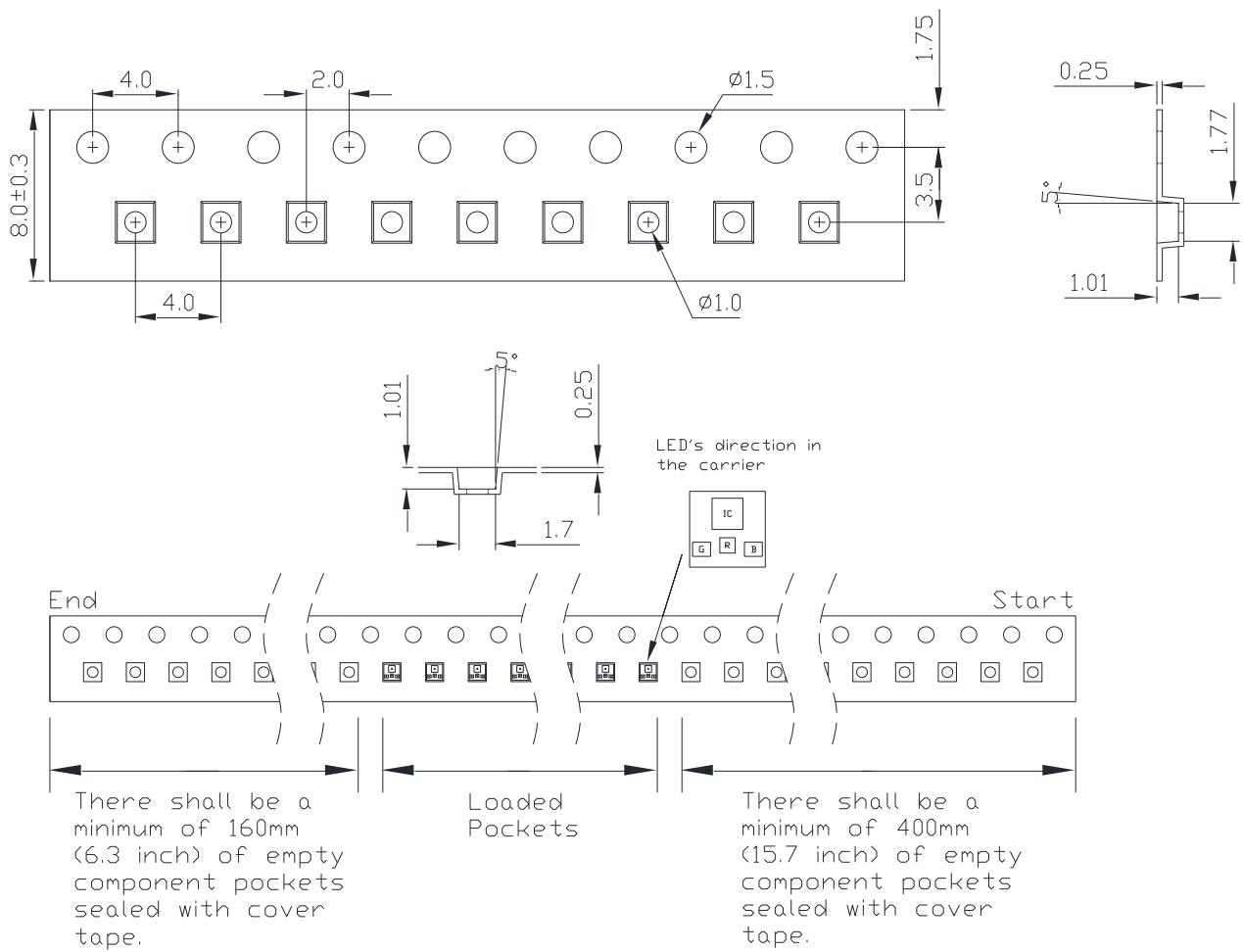
Reflow Soldering Condition

| Profile Feature | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
|--|-------------------------|-------------------|
| Average Ramp-Up Rate ($T_{S_{max}}$ to T_p) | 3°C / second max. | 3°C / second max. |
| Preheat | | |
| - Temperature Min ($T_{S_{min}}$) | 100°C | 150°C |
| - Temperature Max ($T_{S_{max}}$) | 150°C | 200°C |
| - Time ($t_{S_{min}}$ to $t_{S_{max}}$) | 60-120 seconds | 60-180 seconds |
| Time maintained above: | | |
| - Temperature (T_L) | 183°C | 217°C |
| - Time (t_L) | 60-150 seconds | 60-150 seconds |
| Peak/Classification Temperature (T_p) | 240°C | 260°C |
| Time Within 5°C of Actual Peak Temperature (t_p) | 10-30 seconds | 20-40 seconds |
| Ramp-Down Rate | 6°C/second max. | 6°C/second max. |
| Time 25°C to Peak Temperature | 6 minutes max. | 8 minutes max. |



- We recommend using the M705-RGS800HF Type5 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering. Do not use solder pastes with post reflow flux residue >47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.
- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than three times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

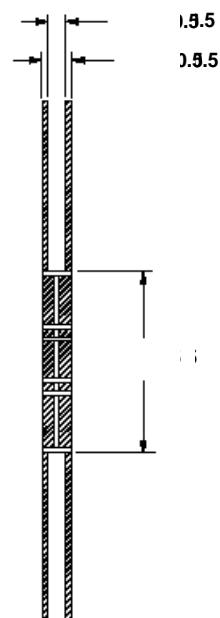
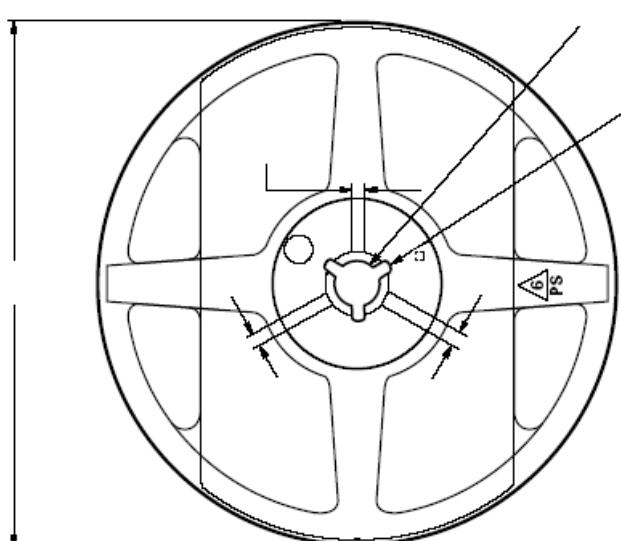
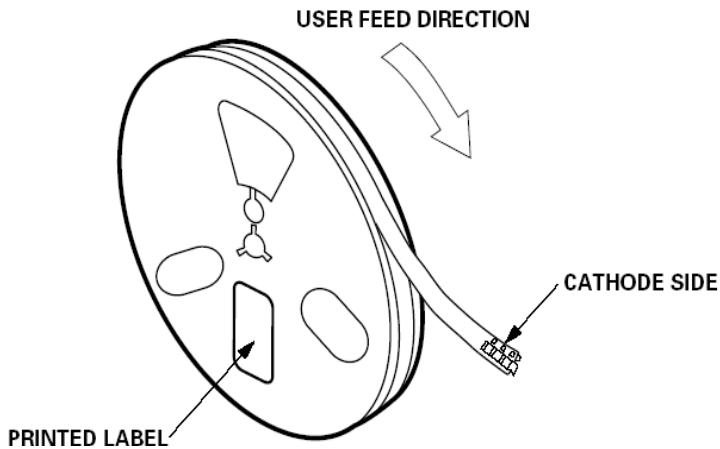
Emitter Reel Packaging



Notes:

1. Drawing not to scale.
2. All dimensions are in millimeters.
3. Unless otherwise indicated, tolerances are ± 0.1mm.

Emitter Reel Packaging



Notes:

1. Empty component pockets sealed with top cover tape.
2. 5,000 pieces per reel.
3. Drawing not to scale.
4. All dimensions are in millimeters.

Precaution for Use

- Storage

Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing the LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30 °C and humidity less than 40% RH. It is also recommended to return the LEDs to the MBB and to reseal the MBB.

- We recommend using the M705-RGS800HF Type5 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue>47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.
- When the LEDs are illuminating, operating current should be decided after considering the package maximum temperature.

Handling of Lens LEDs

Notes for handling of lens LEDs

- Please do not use a force of over 0.3kgf impact or pressure on the lens, otherwise it will cause a catastrophic failure.
- The LEDs should only be picked up by making contact with the sides of the LED body.
- Avoid touching the lens especially by sharp tools such as Tweezers.
- Avoid leaving fingerprints on the lens.
- Please store the LEDs away from dusty areas or seal the product against dust.
- When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the lens must be prevented.
- Please do not mold over the lens with another resin. (epoxy, urethane, etc)

Mouser Electronics

Authorized Distributor

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[AB-PL1515C0I6-5VX0](#)